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MADR-010410

Module Driver
6-bit Serial/Parallel, Transmit/Receive

Features

- CMOS or LVCMOS Control Logic
- Negative output voltage for GaAs Gate Drive
- 6-bit Serial/Parallel Driver for Attenuator or Phase Shifter Control
- T/R Switch and Amplifier Controls
- Low Power Dissipation
- Lead-Free 5mm PQFN-40LD Plastic Package
- RoHS* Compliant and 260°C Reflow Compatible

Description

The MADR-010410 is a dedicated CMOS driver for multifunction modules such as GaAs based Transmit/Receive Modules. The driver translates CMOS/LVCMOS input controls to negative gate control voltages for GaAs FETs.

The driver includes a 6-bit serial/parallel interface designed to drive digital attenuators and/or phase shifters as well as functionality to switch between transmit and receive channels allowing the ability to enable/disable LNAs or PAs. High speed analog CMOS technology is utilized to achieve low power consumption at moderate to high speeds.

Ordering Information[1]

Part Number	Package
MADR-010410-000100	Bulk Packaging
MADR-010410-TR0500	500 piece reel

1. Reference Application Note M513 for reel size information.

Pin Configuration

Pin No.	Function	Pin No.	Function
1	B2	21	NC
2	A2	22	NC
3	B1	23	NC
4	A1	24	NC
5	V_{EE}	25	GND
6	V_{CC}	26	NC
7	S/P	27	P2
8	NC	28	P1
9	NC	29	L2
10	NC	30	L1
11	C1/SER IN	31	B7
12	C2/CLK	32	A7
13	C3/LE	33	B6
14	C4	34	A6
15	C5	35	B5
16	C6	36	A5
17	TR	37	B4
18	ENABLE	38	A4
19	SER OUT	39	B3
20	NC	40	A3

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

Silicon Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

* Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

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Module Driver
6-bit Serial/Parallel, Transmit/Receive

Guaranteed Operating Ranges [2,3,4]

Parameter	Unit	Min.	Typ.	Max.
Positive DC Supply Voltage	V	3.0	5.0	5.5
Negative DC Supply Voltage	V	-5.5	-5.0	-3.0
Operating Temperature	°C	-40	+25	+125

2. Unused logic inputs must be tied to either GND or V_{CC}.
3. All voltages are relative to GND.
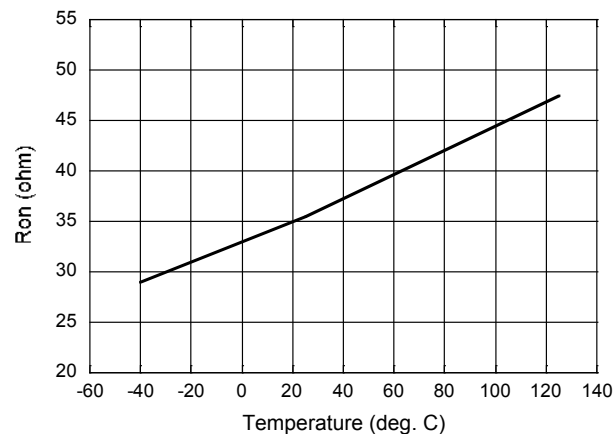4. 0.01 µF decoupling capacitors are required on the power supply lines.

DC Characteristics over Guaranteed Operating Range

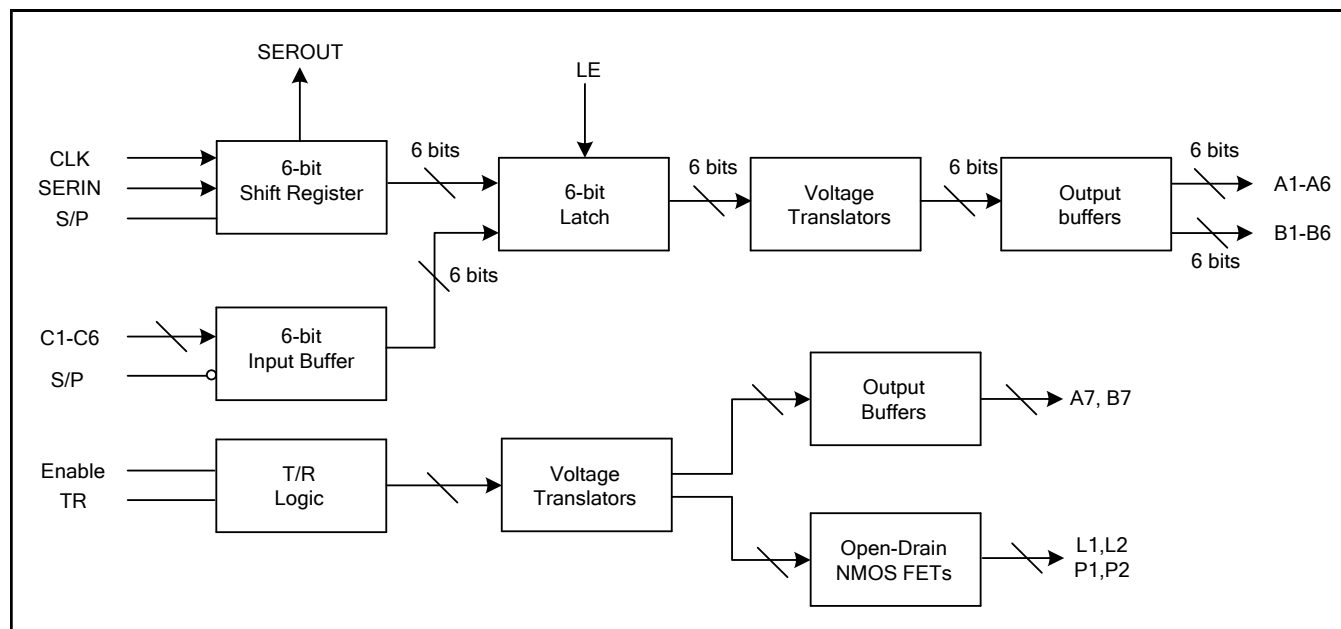| Parameter	Test Conditions	Unit	Min.	Typ.	Max.
Input High Voltage	Guaranteed High Input Voltage	V	$0.7 \times V_{CC}$	V_{CC}	V_{CC}
Input Low Voltage	Guaranteed Low Input Voltage	V	GND	GND	$0.3 \times V_{CC}$
Output High Voltage (An or Bn)	I_{OH} = -250 µA	V	—	-0.1	—
Output Low Voltage (An or Bn)	I_{OL} = 250 µA	V	—	V_{EE} + 0.1	—
DC Output Current—High (per Output)	V_{EE} = -5.0V	mA	-1	—	—
DC Output Current—Low (per Output)	V_{EE} = -5.0V	mA	—	—	1
Output High for Serial Out	I_{OH} = -100 µA	V	V_{CC} - 0.2	—	V_{CC}
Output Low for Serial Out	I_{OL} = 100 µA	V	GND	—	0.2
Output Current High for Serial Out	V_{CC} = 5.0V, V_{EE} = -5.0V	mA	-1	—	—
Output Current Low for Serial Out	V_{CC} = 5.0V, V_{EE} = -5.0V	mA	—	—	1
Quiescent Supply Current	V_{IN} = GND or V_{CC}, No Output Load	µA	—	0.1	5
Quiescent Supply Current	V_{IN} = GND or V_{EE}, No Output Load	µA	—	0.1	5
Input Leakage Current	V_{IN} = GND or V_{CC}	µA	-1	—	1
L,P Ports Open-Drain Output Resistance	V_{EE} = -5.0V or -3.0V, I_{SINK} = 0.5mA	Ω	—	40	200

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Module Driver
6-bit Serial/Parallel, Transmit/Receive

Rev. V2

Absolute Maximum Ratings

Parameter	Unit	Min	Max
DC Supply Voltage Positive	V	-0.5	7.0
DC Supply Voltage Negative	V	-7.0	0.5
DC Input Voltage	V	$V_{CC} - 0.5$	7.0
Operating Temperature	°C	-55	125
Storage Temperature	°C	-65	150
ESD Sensitivity	kV	2	—

Ln/Pn Output On Resistance

Function Diagram

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MADR-010410

![MACOM logo]

Functionality

6-bit Serial/Parallel Driver

The 6-bit serial/parallel driver consists of C1-C6 (shared inputs), S/P (mode control), A1 to A6 (in phase outputs), B1 to B6 (complementary outputs), and SerOut.

The serial control interface (SERIN, CLK, LE, SE-ROUT) is compatible with SPI protocol. It is activated when S/P is kept high. The 6-bit serial word must be loaded with MSB first. When LE is high, 6-bit data in the serial input register will be transferred to complementary An and Bn outputs. CLK will be   masked to prevent data transition during output loading. SEROUT is the SERIN delayed by 6 clock cycles.

The parallel mode is enabled when S/P is set to low. In the parallel mode, the outputs are controlled by the parallel control inputs (C1 to C6) directly.

T/R Control

The A7 and B7 outputs are designed to drive the SP2T switch(es) in the T/R module. which switch the T/R module between transmit and receive modes.

The combination of TR and Enable inputs will be able to turn on/off the T/R module receive path LNAs and transmit path PAs. Inside L and P outputs are open-drain NMOS FETs. When they are turned on, they will pull down the gate of the GaAs FETs in the amplifiers to shut them down. See Figure 1 for the application circuit.
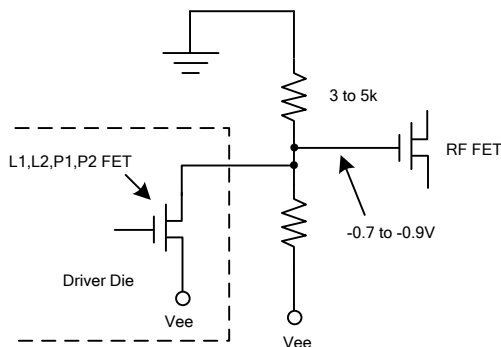
Figure 1. Application Circuit for T/R Amplifiers Control

Mode Truth Table

S/P	LE	Mode
1	X	Serial
0	N/A	Direct Parallel

Parallel Mode Truth Table

INPUTs C1-C6	OUTPUTS	
	A1-A6	B1-B6
0	V_{EE}	GND
1	GND	V_{EE}

T/R Logic Truth Table

INPUTS		OUTPUTS			
Enable	TR	A7	B7	L1, L2	P1, P2
0	1	GND	V_{EE}	Hi Z	Hi Z
0	0	V_{EE}	GND	Hi Z	Hi Z
1	1	GND	V_{EE}	Hi Z	Low
1	0	V_{EE}	GND	Low	Hi Z

Where:

"Low" means that the NMOS FET is on (pulls the gate to approximately $V_{EE} + 0.2V$).

"Hi Z" means that the open-drain NMOS FET is shut down and shows a high impedance.

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Serial Interface Timing Diagram
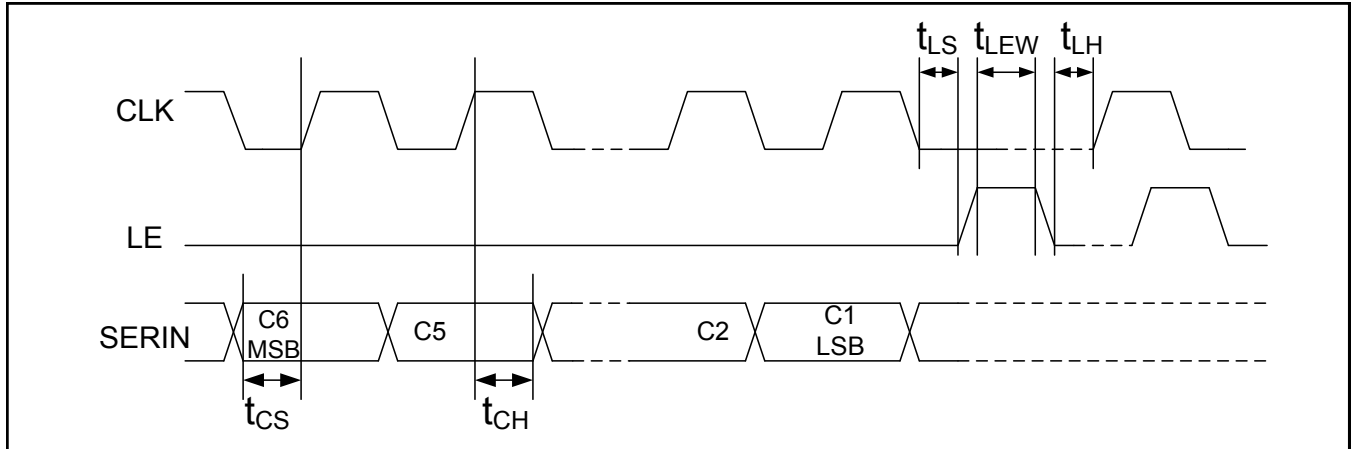
Serial Interface Timing Characteristics

Symbol	Parameter	Unit	Typical performance		
			-40°C	+25°C	+125°C
t_{CKH}	Min. Serial Clock HIGH Period	ns	50	50	50
t_{CKL}	Min. Serial Clock LOW Time	ns	50	50	50
t_{CS}	Min. Control Set-up Time	ns	20	20	20
t_{CH}	Min. Control Hold Time	ns	20	20	20
t_{LS}	Min. LE Set-up Time	ns	20	20	20
t_{LEW}	Min. LE Pulse Width	ns	20	20	20
t_{LH}	Min. LE Hold Time	ns	20	20	20

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Parallel Interface Characteristics Over Guaranteed Operating Range[5]

Symbol	Parameter	Unit	Typical performance		
			-40°C	+25°C	+125°C
T_{PLH}	Propagation Delay	ns	22	24	28
T_{PHL}	Propagation Delay	ns	22	24	28
T_{TLH}	Output Transition Time (Rising Edge)	ns	6	7	8
T_{THL}	Output Transition Time (Falling Edge)	ns	4	5	6
T_{skew}	Delay Skew	ns	1	1	1

5. V_{CC} = 3.0V, V_{EE} = -3.0V, C_L = 2 pF, input LOGIC1 = 3V, LOGIC0 = 0V, Trise, Tfall = 6 ns.

Switching Waveforms

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Lead-Free, 5mm QFN-40LD†

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†   Reference Application Note M538 for lead-free solder reflow recommendations.
     Plating is 100% matte tin over copper.
     Meets JEDEC moisture sensitivity level 3 requirements.

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